

General Purpose Transistors

NPN Silicon

FEATURE

- Simplifies Circuit Design.
- RoHS product for packing code suffix "G"
Halogen free product for packing code suffix "H"

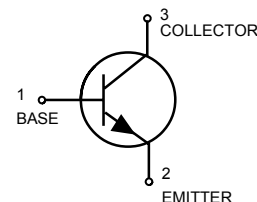
ORDERING INFORMATION

Device	Marking	Shipping
MMBT3904TT1	MA	3000/Tape&Reel


SOT-523

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	40	Vdc
Collector–Base Voltage	V_{CBO}	60	Vdc
Emitter–Base Voltage	V_{EBO}	6.0	Vdc
Collector Current — Continuous	I_C	200	mAdc



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR– 4 Board, (1) $T_A = 25^\circ\text{C}$	P_D	200	mW
Derate above 25°C		1.6	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	600	$^\circ\text{C}/\text{W}$
Total Device Dissipation FR-4 Board(2), $T_A = 25^\circ\text{C}$	P_D	300	mW
Derate above 25°C		2.4	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	400	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	T_J, T_{sig}	-55 to +150	$^\circ\text{C}$

DEVICE MARKING

MMBT3904TT1 = MA

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
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OFF CHARACTERISTICS

Collector–Emitter Breakdown Voltage(3) ($I_C = 1.0 \text{ mAdc}$)	$V_{(BR)CEO}$	40	—	Vdc
Collector–Base Breakdown Voltage ($I_C = 10 \mu\text{Adc}$)	$V_{(BR)CBO}$	60	—	Vdc
Emitter–Base Breakdown Voltage ($I_E = 10 \mu\text{Adc}$)	$V_{(BR)EBO}$	6.0	—	Vdc
Base Cutoff Current ($V_{CE} = 30 \text{ Vdc}, V_{EB} = 3.0 \text{ Vdc}$)	I_{BL}	—	50	nAdc
Collector Cutoff Current ($V_{CE} = 30 \text{ Vdc}, V_{BE} = 3.0 \text{ Vdc}$)	I_{CEX}	—	50	nAdc

1. FR-4 Minimum Pad.
2. FR-4 1.0 x 1.0 Inch Pad.
3. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.



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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
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ON CHARACTERISTICS (3)

DC Current Gain(1) (I _C = 0.1 mA _{dc} , V _{CE} = 1.0 V _{dc}) (I _C = 1.0 mA _{dc} , V _{CE} = 1.0 V _{dc}) (I _C = 10 mA _{dc} , V _{CE} = 1.0 V _{dc}) (I _C = 50mA _{dc} , V _{CE} = 1.0V _{dc}) (I _C = 100mA _{dc} , V _{CE} = 1.0 V _{dc})	h _{FE}	40 70 100 60 30	— — 300 — —	—
Collector–Emitter Saturation Voltage (I _C = 10 mA _{dc} , I _B = 1.0 mA _{dc})(3) (I _C = 50 mA _{dc} , I _B = 5.0mA _{dc})	V _{CE(sat)}	— —	0.2 0.3	V _{dc}
Base–Emitter Saturation Voltage(3) (I _C = 10 mA _{dc} , I _B = 1.0mA _{dc}) (I _C = 50mA _{dc} , I _B = 5.0mA _{dc})	V _{BE(sat)}	0.65 —	0.85 0.95	V _{dc}

SMALL–SIGNAL CHARACTERISTICS

Current–Gain — Bandwidth Product (I _C = 10mA _{dc} , V _{CE} = 20V _{dc} , f = 100MHz)	f _T	200	—	MHz
Output Capacitance (V _{CB} = 5.0V _{dc} , I _E = 0, f = 1.0 MHz)	C _{obo}	—	4.0	pF
Input Capacitance (V _{BE} = 0.5V _{dc} , I _C = 0, f = 1.0 MHz)	C _{ibo}	—	8.0	pF
Input Impedance (V _{CE} = 10V _{dc} , I _C = 1.0mA _{dc} , f = 1.0 kHz)	h _{ie}	1.0	10	pF
Voltage Feedback Ratio (V _{CE} = 10 V _{dc} , I _C = 1.0 mA _{dc} , f = 1.0 kHz)	h _{re}	0.5	8.0	X10 ⁻⁴
Small–Signal Current Gain (V _{CE} = 10 V _{dc} , I _C = 1.0 mA _{dc} , f = 1.0 kHz)	h _{fe}	100	400	—
Output Admittance (V _{CE} = 10 V _{dc} , I _C = 1.0 mA _{dc} , f = 1.0 kHz)	h _{oe}	1.0	40	Ωmhos
Noise Figure (V _{CE} = 5.0 V _{dc} , I _C = 100μA _{dc} , R _S = 1.0 k Ω, f = 1.0 kHz)	NF	—	5.0	dB

SWITCHING CHARACTERISTICS

Delay Time (V _{CC} = 3.0 V _{dc} , V _{BE} = 0.5V _{dc})	t _d	—	35	ns
Rise Time (I _C = 10 mA _{dc} , I _{B1} = 1.0mA _{dc})	t _r	—	35	ns
Storage Time (V _{CC} = 3.0V _{dc} ,	t _s	—	200	ns
Fall Time (I _C = 10 mA _{dc} , I _{B1} = I _{B2} = 1.0mA _{dc})	t _f	—	50	ns

3. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

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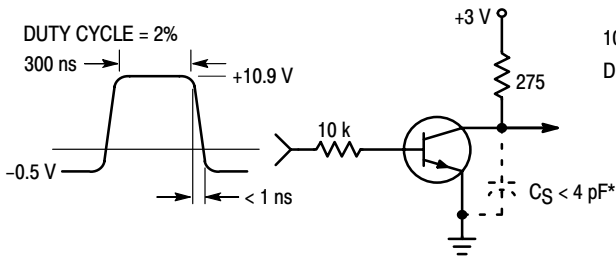


Figure 1. Delay and Rise Time Equivalent Test Circuit

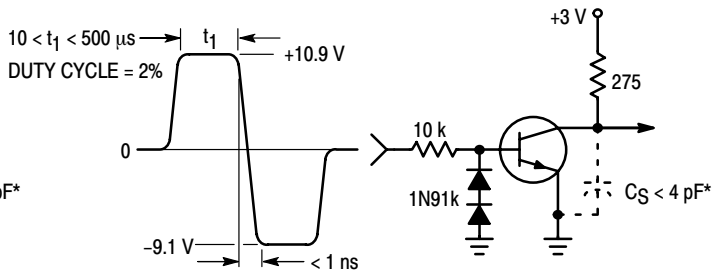


Figure 2. Storage and Fall Time Equivalent Test Circuit

* Total shunt capacitance of test jig and connectors

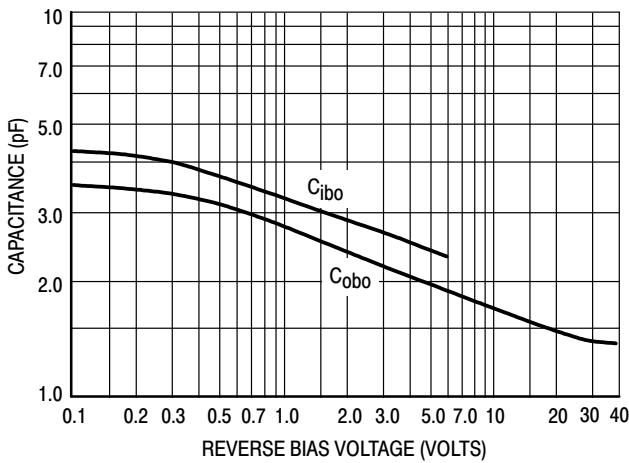


Figure 3. Capacitance

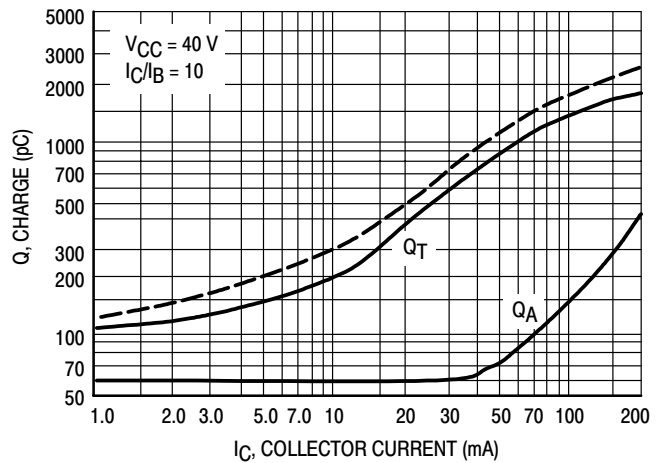


Figure 4. Charge Data

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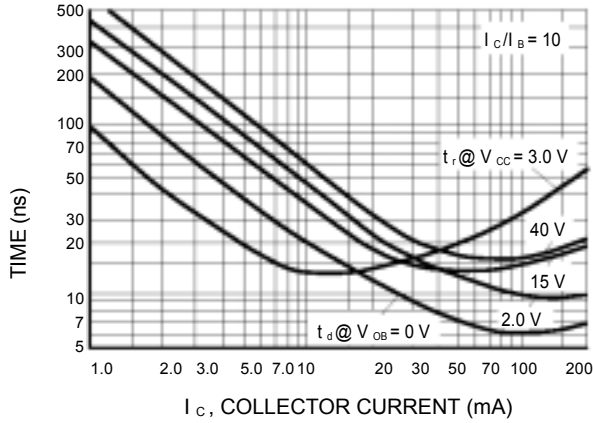


Figure 5. Turn-On Time

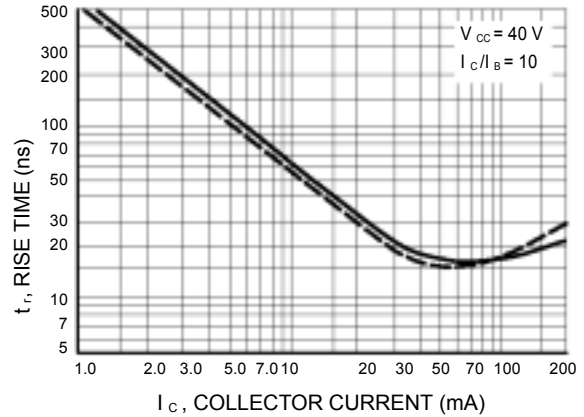


Figure 6. Rise Time

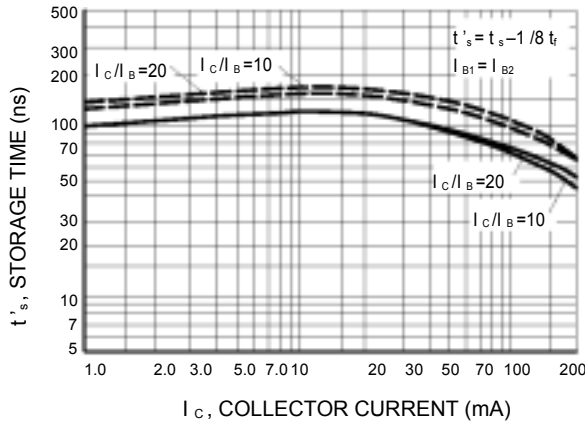


Figure 7. Storage Time

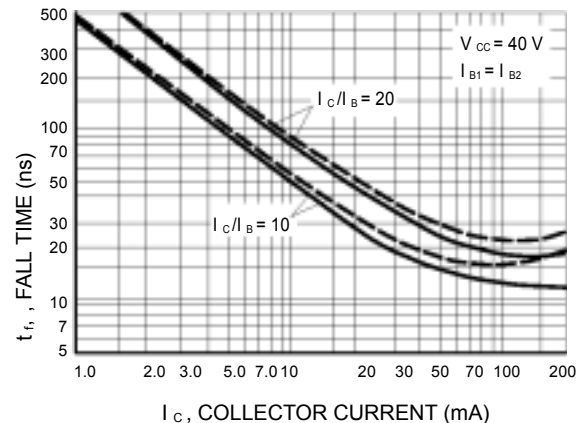


Figure 8. Fall Time

**TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS
NOISE FIGURE VARIATIONS**

($V_{CE} = 5.0 \text{ Vdc}$, $T_A = 25^\circ\text{C}$, Bandwidth = 1.0 Hz)

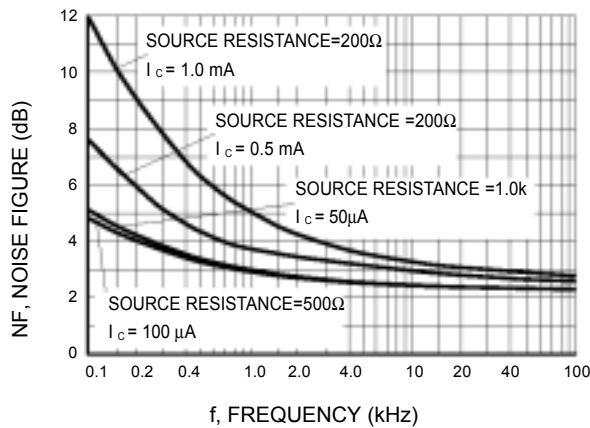


Figure 9.

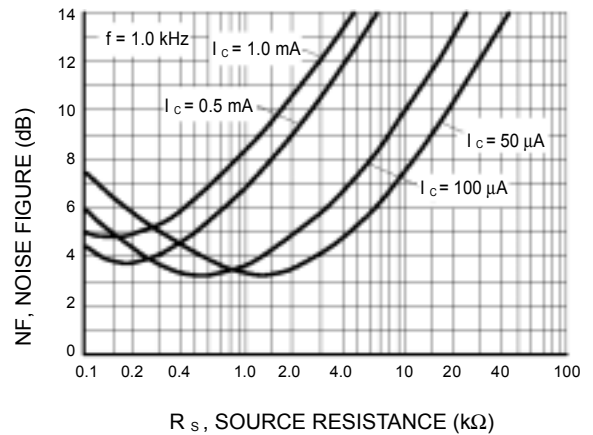


Figure 10.



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h PARAMETERS

($V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$, $T_A = 25^\circ\text{C}$)

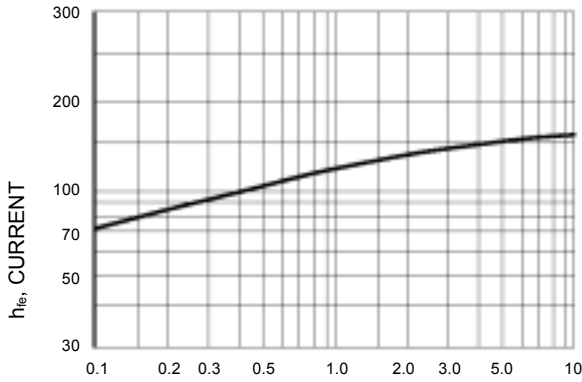


Figure 11. Current Gain

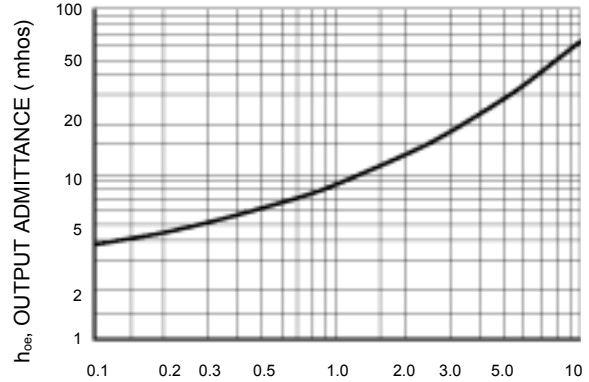


Figure 12. Output Admittance

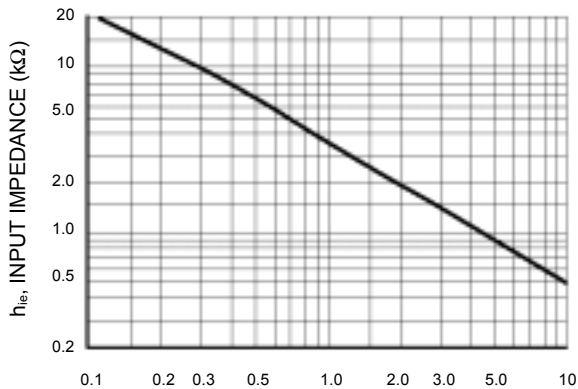


Figure 13. Input Impedance

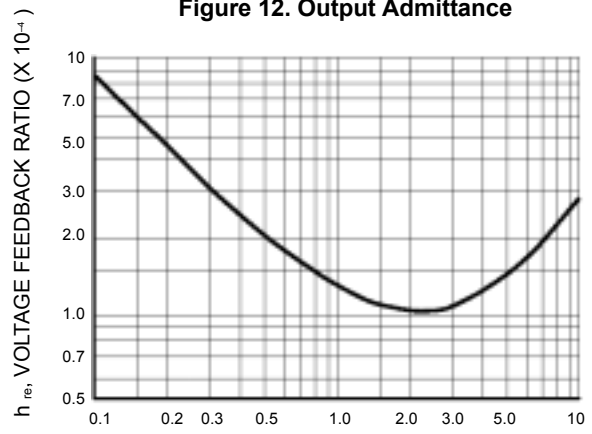


Figure 14. Voltage Feedback Ratio

TYPICAL STATIC CHARACTERISTICS

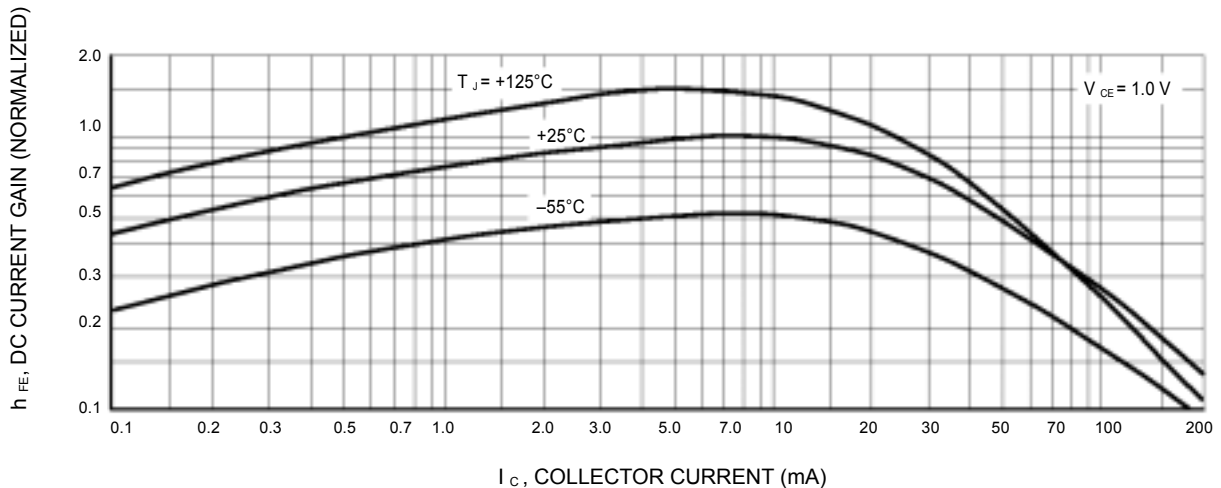


Figure 15. DC Current Gain



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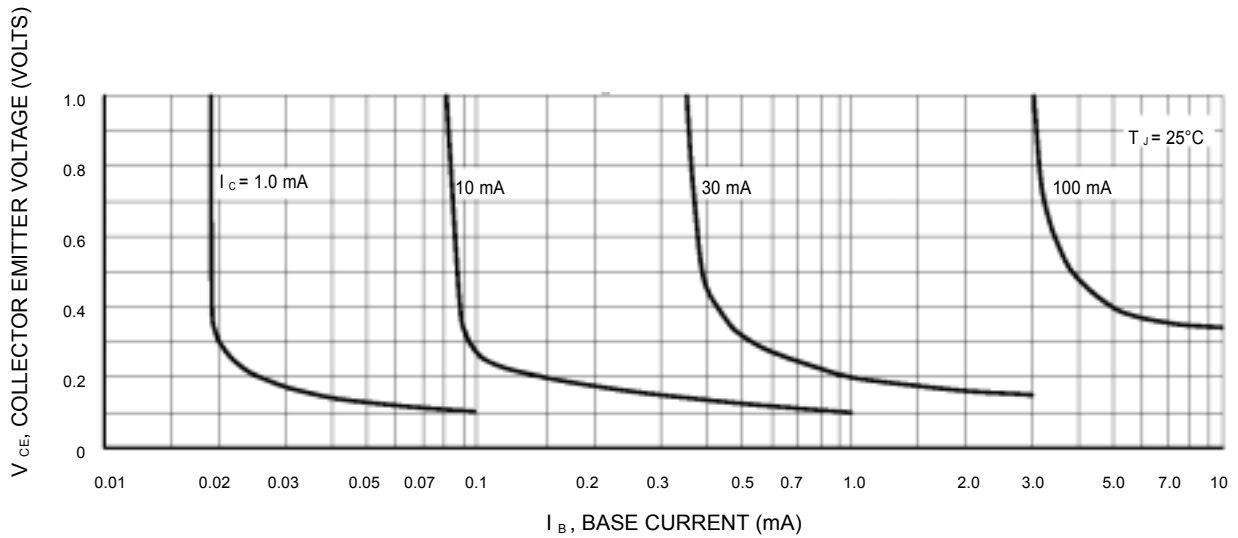


Figure 16. Collector Saturation Region

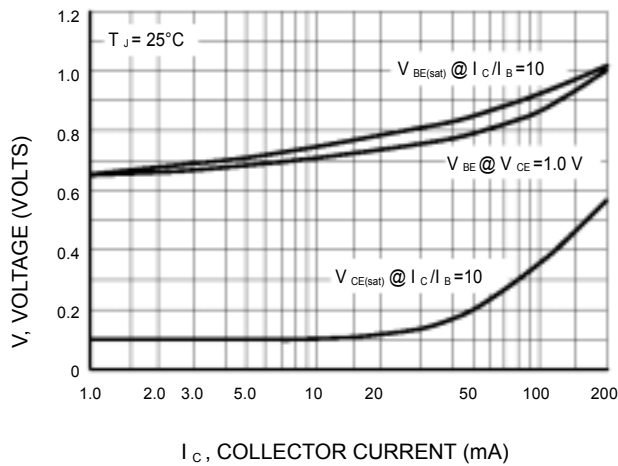


Figure 17. "ON" Voltages

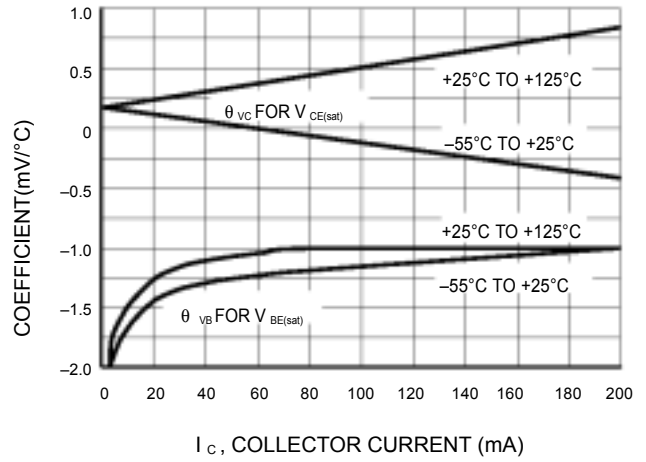
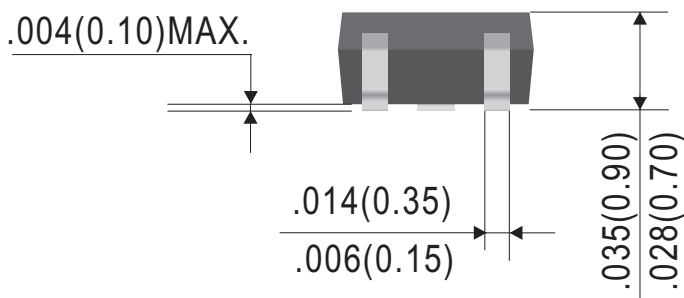
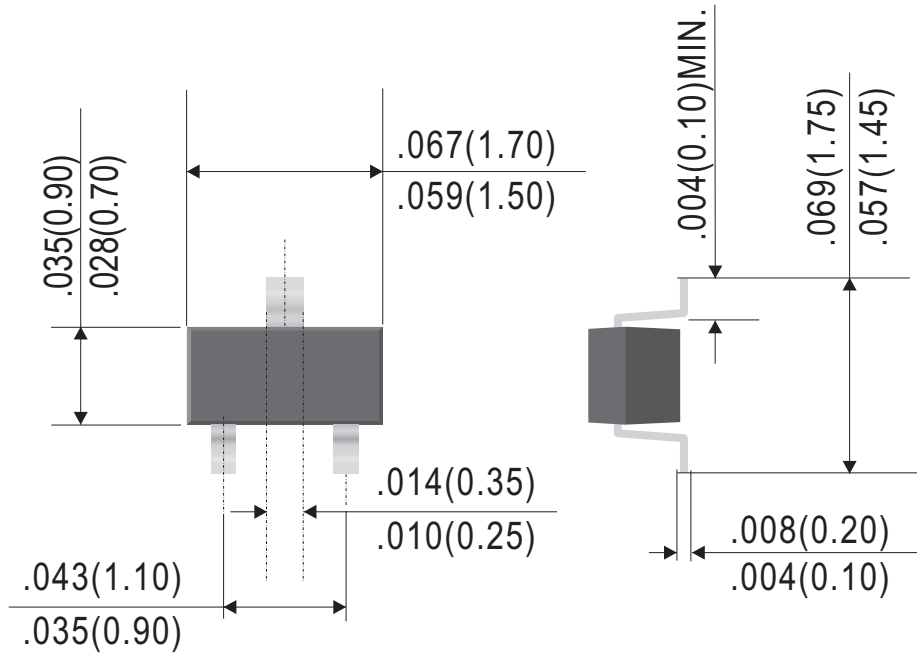


Figure 18. Temperature Coefficients

SUV-523



Dimensions in inches and (millimeters)